PALM Intranet						
Application Number	· · · · ·	SEARCH				
IDS Flag Cle	arance for App	olication 1064506	5			
IDS Information	,				·	
	Content	Mailroom Date	Entry Number	IDS Review	Reviewer	
	M844	08-22-2003	9	<u> </u>	08-10-2005 23:47:56	IDS CONV
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Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	3092	(134/113 156/345.55 134/50 134/52 134/119 134/190 134/902)	US-PGPUB; USPAT	OR	OFF	2005/11/11 08:47
L2	2215	1 and (wafer semiconductor substrate)	US-PGPUB; USPAT	OR	OFF	2005/11/11 08:47
L3	1314	2 and (plate shield\$3 cover)	US-PGPUB; USPAT	OR	OFF	2005/11/11 09:12
L4	146	2 and (top shield\$3 block\$3) adj3 plate	US-PGPUB; USPAT	OR	OFF	2005/11/11 09:06
L5	5	(("6536454") or ("4871417") or ("6431190") or ("20030196683") or ("6405739") or ("20030196683")).PN.	US-PGPUB; USPAT	OR	OFF	2005/11/11 09:09
L6	1534	yokouchi-k\$.in. hara-t\$.in. araki-h\$.in. okumura-t\$.in.	US-PGPUB; USPAT	OR	OFF	2005/11/11 09:13
L7	356	6 and (wafer semiconductor)	US-PGPUB; USPAT	OR	OFF	2005/11/11 09:13
L8	22	7 and (156/345.\$ "134"/\$)	US-PGPUB; USPAT	OR	OFF	2005/11/11 09:15
L9	3153	(spin\$4 turn\$3 rotat\$3) with (wafer semiconductor) same (plate shield cover)	JPO; DERWENT	OR	OFF	2005/11/11 09:17
L10	3153	((spin\$4 turn\$3 rotat\$3) with (wafer semiconductor)) same (plate shield cover)	JPO; DERWENT	OR	OFF	2005/11/11 09:17
L11	484	10 and (etch\$3 clean\$3 rins\$3)	JPO; DERWENT	OR	OFF	2005/11/11 09:18